

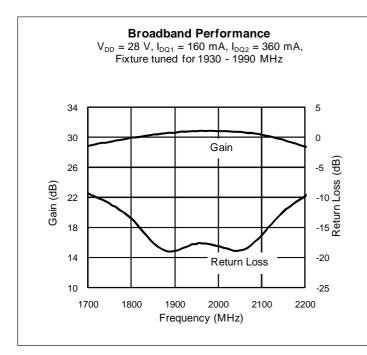




Wideband RF LDMOS Integrated Power Amplifier 40 W, 28 V, 1800 – 2100 MHz

Description

The PTMA180402M is a matched, wideband, 2-stage, 40-watt LDMOS integrated amplifier intended for base station applications in the 1800 to 2100 MHz frequency band. This device is offered in a 20-pin, thermally-enhanced, overmolded plastic package for cool and reliable operation.



PTMA180402M Package PG-DSO-20-63



Features

- Designed for wide RF bandwidth and low memory effects
- On-chip matching, integrated input DC block, 50-ohm input and ~4-ohm output
- Typical single-carrier CDMA performance at 1960 MHz, 28 V
 - Average output power = 5 W
 - Linear gain = 30 dB
 - Efficiency = 16%
 - Adjacent channel power = -52 dBc
- Typical two-tone CW performance at 1960 MHz, 28 V
 - Output power (PEP) = 40 W at IMD3 = -30 dBc Efficiency = 34%
- Capable of handling 10:1 VSWR @ 28 V, 40 W (CW) output power
- Integrated ESD protection. Meets HBM Class 1B (minimum), per JESD22-A114F
- Thermally-enhanced, RoHS-compliant package

RF Characteristics

CDMA Measurements (tested in Infineon production test fixture)

				Unit
G _{ps}	28	30	—	dB
η _D	14	16	—	%
ACPR	_	-52	-50	dBc
	η _D	η _D 14	η _D 14 16 ACPR — -52	η _D 14 16 — ACPR — -52 -50

RF Characteristics continued next page

All published data at T_{CASE} = 25°C unless otherwise indicated

ESD: Electrostatic discharge sensitive device—observe handling precautions!



RF Characteristics (cont.)

Two-tone Specifications (not subject to production test—verified by design/characterization in Infineon test fixture) $V_{DD} = 28 \text{ V}$, $I_{DQ1} = 160 \text{ mA}$, $I_{DQ2} = 360 \text{ mA}$, $P_{OUT} = 40 \text{ W}$ PEP, f = 1960 MHz, tone spacing = 1 MHz

Characteristic	Symbol	Min	Тур	Мах	Unit
Gain	G _{ps}	_	30		dB
Power Added Efficiency	PAE	—	34	—	%
Third Order Intermodulation Distortion	IMD3	_	-32	_	dBc

DC Characteristics

Stage 1 Characteristics Conditions Sy		Symbol	Min	Тур	Мах	Unit
Drain Leakage Current	$V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V}$	$V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V}$ I_{DSS}		_	1.0	μA
	$V_{DS} = 63 \text{ V}, V_{GS} = 0 \text{ V}$	I _{DSS}			10.0	μA
Gate Leakage Current	rrent $V_{GS} = 10 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				1.0	μA
On-state Resistance	V_{GS} = 10 V, V_{DS} = 0.1 V	R _{DS(on)}		1.6		Ω
Operating Gate Voltage	V _{DS} = 28 V, I _{DQ1} = 160 m	nA, V _{GS}	2.0	2.5	3.0	V

Stage 2 Characteristics Conditions		Symbol	Min	Тур	Max	Unit
rain-source Breakdown Voltage $V_{GS} = 0 V$, $I_{DS} = 10 mA$		V _{(BR)DSS}	65	_		V
Drain Leakage Current	$V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V}$	I _{DSS}	_	_	1.0	μA
	$V_{DS} = 63 \text{ V}, V_{GS} = 0 \text{ V}$	I _{DSS}	_	—	10.0	μA
Gate Leakage Current	V_{GS} = 10 V, V_{DS} = 0 V	I _{GSS}	_	_	1.0	μA
On-state Resistance	V_{GS} = 10 V, V_{DS} = 0.1 V	R _{DS(on)}	_	0.21		Ω
Operating Gate Voltage	V _{DS} = 28 V, I _{DQ2} = 360 m	A V _{GS}	2.0	2.5	3.0	V



Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	65	V
Gate-Source Voltage		V _{GS}	-0.5 to +12	V
Junction Temperature		TJ	200	°C
Total Device Dissipation		PD	175	W
Above 25°C derate by			1.0	W/°C
Storage Temperature Range		T _{STG}	-40 to +150	°C
Overall Thermal Resistance (T _{CASE} = 70°C, 40 W CW)	Stage 1	$R_{\theta JC}$	3.6	°C/W
P _{OUT} = 40 W, I _{DQ1} = 160 mA, I _{DQ2} = 360 mA	Stage 2	$R_{\theta JC}$	1.5	°C/W

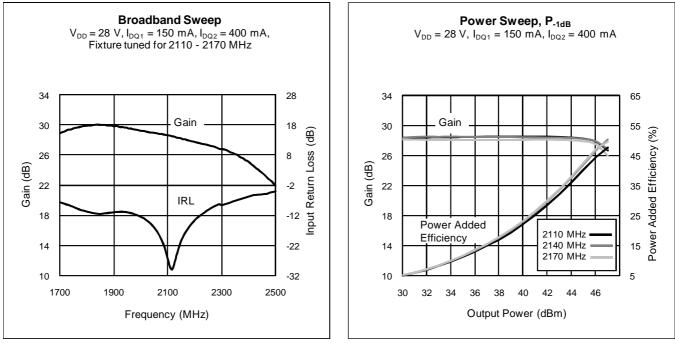
Moisture Sensitivity Level

Level	Test Standard	Package Temperature	Unit
3	IPC/JEDEC J-STD-020	260	°C

Ordering Information

Type and Version	Package Outline	Package Description	Shipping
PTMA180402M V1	PG-DSO-20-63	Copper heat slug, plastic EMC body	Таре

Typical Performance, circuit tuned for 2140 MHz (data taken in Infineon test fixture)



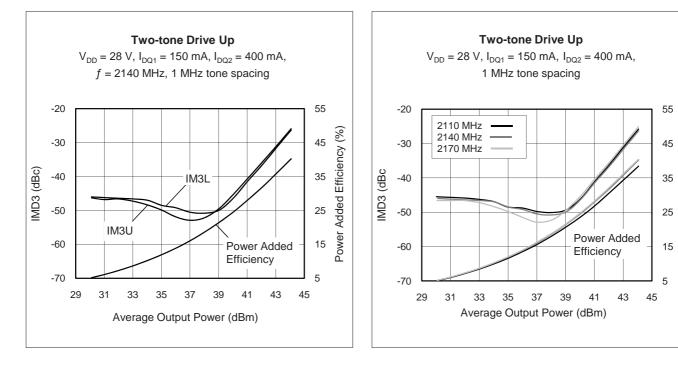
Data Sheet



Power Added Efficiency (%)

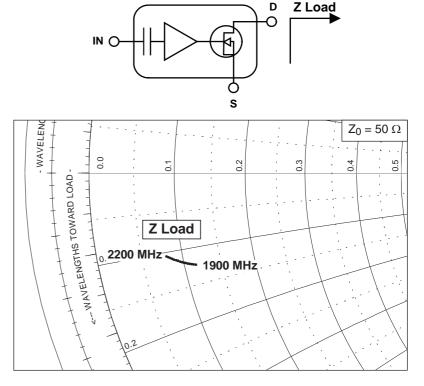


Typical Performance, circuit tuned for 2140 MHz (cont.)



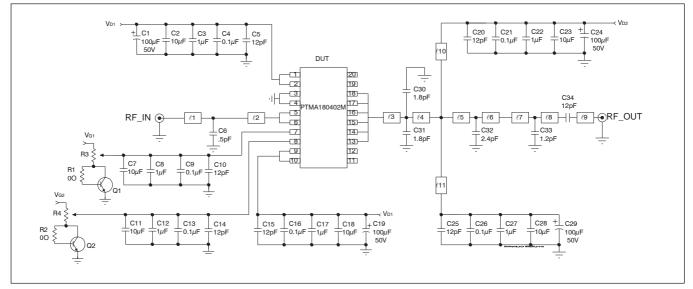
Broadband Circuit Impedance — 2140 MHz

Frequency	Z Loa	ad Ω
MHz	R	jХ
1900	5.76	-6.18
1920	5.63	-6.13
1940	5.51	-6.09
1960	5.39	-6.04
1980	5.27	-5.99
2000	5.15	-5.93
2020	5.03	-5.88
2040	4.92	-5.82
2060	4.80	-5.76
2080	4.68	-5.69
2100	4.57	-5.63
2120	4.45	-5.56
2140	4.34	-5.49
2160	4.23	-5.41
2180	4.12	-5.34
2200	4.01	-5.26





Reference Circuit, tuned for 2140 MHz



Reference circuit schematic for f = 2140 MHz

Circuit Description

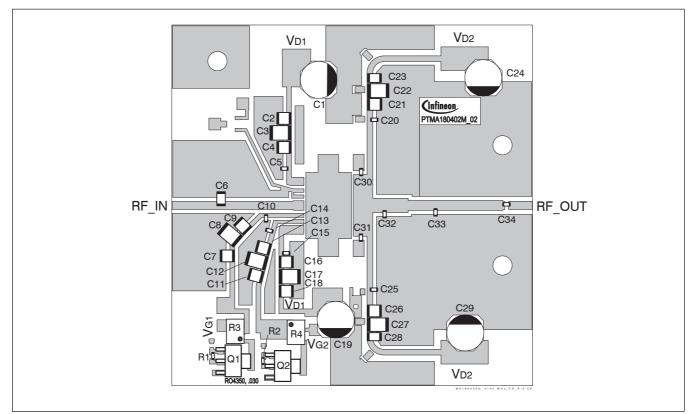
DUT	PTMA180402M	LDMOS IC		
PCB	Rogers RO4350, 0.7	Rogers RO4350, 0.76 mm [.030"] thick, εr = 3.48, 1 oz. copper		
Test fixture part no.	LTN/PTMA180402M			
Find Gerber files for this test fixture on the Infineon Web site at http://www.infineon.com/rfpower				

Circuit Assem	bly Information		
Microstrip	Electrical Characteristics	Dimensions: L x W (mm)	Dimensions: L x W (in.)
	at 2140 MHz		
<i>ℓ</i> 1	0.150 λ, 50.0 Ω	12.73 x 1.70	0.501 x 0.067
<i>l</i> 2	0.177 λ, 50.0 Ω	15.04 x 1.70	0.592 x 0.067
<i>ℓ</i> 3	0.026 λ, 10.4 Ω	2.01 x 13.00	0.079 x 0.512
<i>ℓ</i> 4	0.026 λ, 10.4 Ω	2.06 x 13.00	0.081 x 0.512
<i>ℓ</i> 5	0.026 λ, 34.2 Ω	2.13 x 3.00	0.084 x 0.118
<i>ℓ</i> 6	0.054 λ, 34.2 Ω	4.45 x 3.00	0.175 x 0.118
<i>ℓ</i> 7	0.066 λ, 43.5 Ω	5.56 x 2.11	0.219 x 0.083
<i>l</i> 8	0.178 λ, 43.5 Ω	14.96 x 2.11	0.589 x 0.083
<i>ℓ</i> 9	0.059 λ, 50.0 Ω	5.03 x 1.70	0.198 x 0.067
<i>l</i> 10, <i>l</i> 11	0.137 λ, 47.8 Ω	11.56 x 1.83	0.455 x 0.072

PTMA180402M



Reference Circuit — 2140 MHz (cont.)



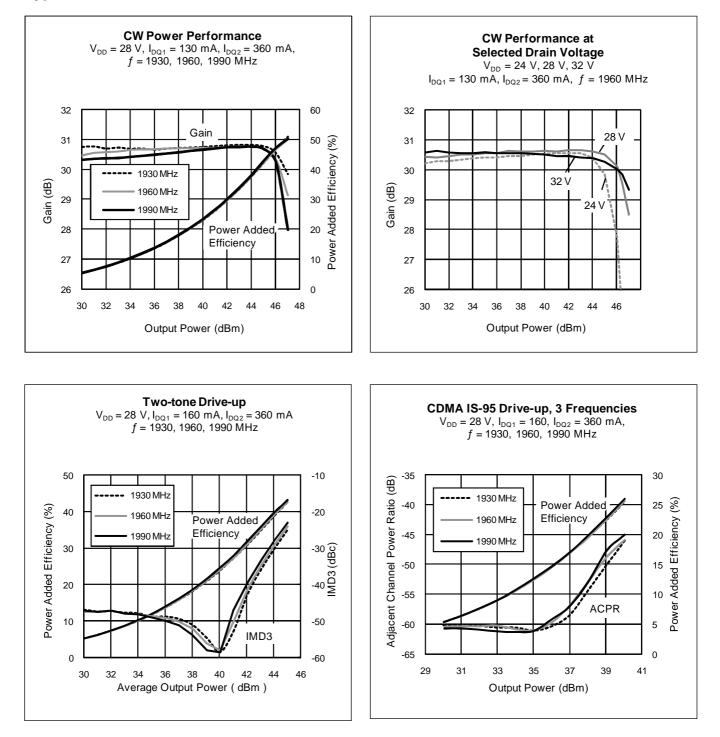
Assembly diagram for 2140 MHz reference circuit (not to scale)

Component	Description	Suggested Manufacturer	P/N or Comment
C1, C19, C24, C29	Electrolytic capacitor, 100 µF, 50 V	Digi-Key	PCE3718CT-ND
C2, C7, C11, C18, C23, C28	Ceramic capacitor, 10 µF	Murata	GRM422Y5V106Z050AL
C3, C8, C12, C17, C22, C27	Ceramic capacitor, 1 µF	Digi-Key	445-1411-2-ND
C4, C9, C13, C16, C21, C26	Capacitor, 0.1 µF	Digi-Key	399-1267-2-ND
C5, C10, C12, C15, C20, C25, C34	Ceramic capacitor, 12 pF	ATC	600S120JT
C6	Ceramic capacitor, 0.5 pF	ATC	100B 0R5
C30, C31	Ceramic capacitor, 1.8 pF	ATC	600S1R8CT
C32	Ceramic capacitor, 2.4 pF	ATC	100B 2R4
C33	Ceramic capacitor, 1.2 pF	ATC	100B 1R2
Q1, Q2	Transistor	Infineon Technologies	BCP56
R1, R2	Resistor, 0 Ω	Digi-Key	603
R3, R4	Potentiometer, 2k Ω	Digi-Key	3224W-202ETR-ND





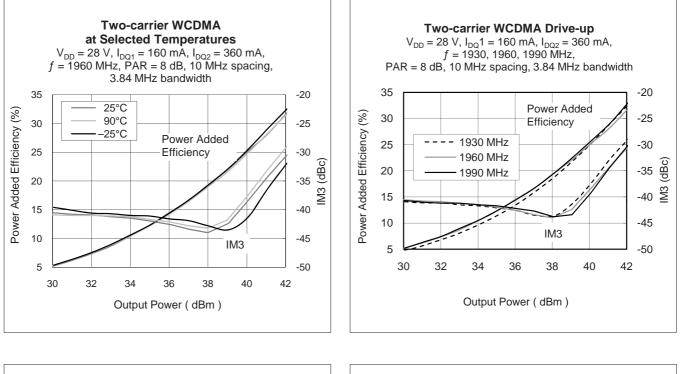
Typical Performance, circuit tuned for 1960 MHz (data taken in a production test fixture)

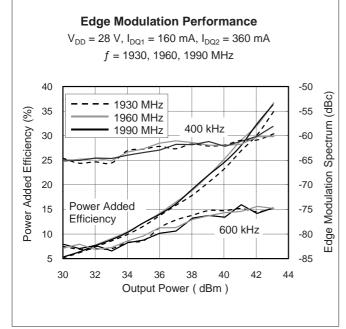


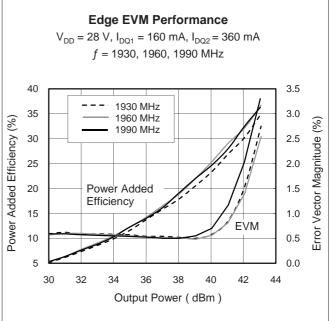
PTMA180402M



Typical Performance —1960 MHz (cont.)



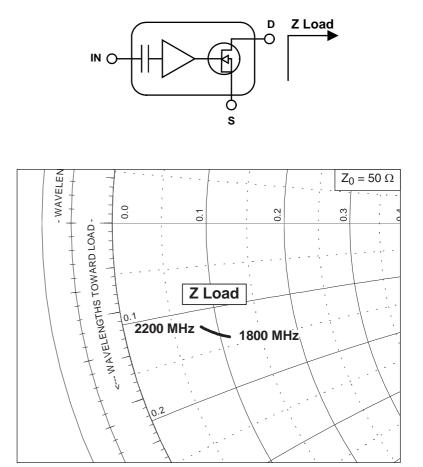






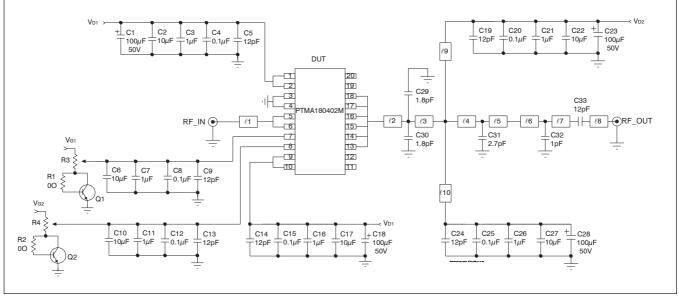
Broadband Circuit Impedance — 1960 MHz

Frequency	Z Load Ω		
MHz	R	jХ	
1800	5.56	-6.95	
1810	5.48	-6.91	
1820	5.39	-6.87	
1830	5.31	-6.83	
1840	5.23	-6.79	
1850	5.15	-6.75	
1860	5.07	-6.70	
1870	4.99	-6.66	
1880	4.91	-6.61	
1890	4.84	-6.56	
1900	4.76	-6.51	
1910	4.69	-6.47	
1920	4.61	-6.42	
1930	4.54	-6.36	
1940	4.47	-6.31	
1950	4.40	-6.26	
1960	4.33	-6.21	
1970	4.26	-6.15	
1980	4.19	-6.10	
1990	4.12	-6.04	
2000	4.06	-5.99	





Reference Circuit, tuned for 1960 MHz



Reference circuit schematic for f = 1960 MHz

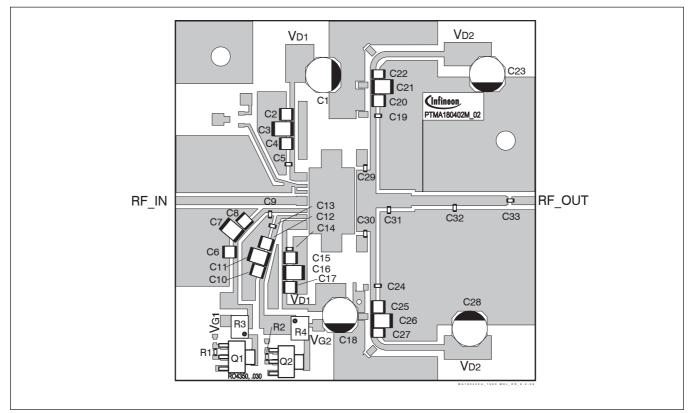
Circuit Description

_			
DUT	PTMA180402M	LDMOS IC	
PCB	Rogers RO4350, 0.76 mm [.030"] thick, εr = 3.48, 1 oz. copper		
Test Fixture Part No.	LTN/PTMA180402M		
Find Gerber files for this	s test fixture on the Infined	on Web site at http://www.infineon.com/rfpower	

Microstrip	Electrical Characteristics	Dimensions: L x W (mm)	Dimensions: L x W (in.)		
	at 1960 MHz				
<i>ℓ</i> 1	0.300 λ,50.0 Ω	27.76 x 1.70	1.093 x 0.067		
<i>l</i> 2	0.024 λ,10.4 Ω	2.01 x 13.00	0.079 x 0.512		
<i>ℓ</i> 3	0.024 λ,10.4 Ω	2.06 x 13.00	0.081 x 0.512		
<i>ℓ</i> 4	0.037 λ,34.2 Ω	3.35 x 3.00	0.132 x 0.118		
<i>ℓ</i> 5	0.046 λ,34.2 Ω	4.11 x 3.00	0.162 x 0.118		
<i>ℓ</i> 6	0.097 λ,34.2 Ω	8.76 x 3.00	0.345 x 0.118		
<i>ℓ</i> 7	0.127 λ,43.6 Ω	11.63 x 2.11	0.458 x 0.083		
<i>l</i> 8	0.054 λ,50.0 Ω	5.03 x 1.70	0.198 x 0.067		
<i>ℓ</i> 9, <i>ℓ</i> 10	0.125 λ,47.8 Ω	11.56 x 1.83	0.455 x 0.072		



Reference Circuit — 1960 MHz (cont.)



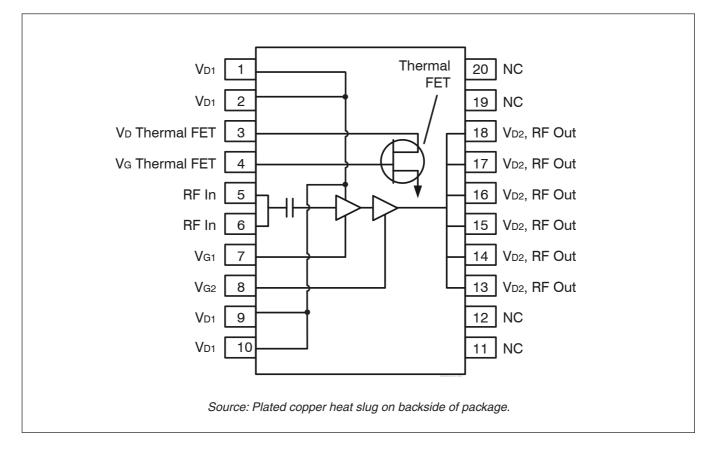
Assembly diagram for 1960 MHz reference circuit (not to scale)

Component Description		Suggested Manufacturer	P/N or Comment	
C1, C18, C23, C28	Electrolytic capacitor, 100 µF, 50 V	Digi-Key	PCE3718CT-ND	
C2, C6, C10, C17, C22, C27	Ceramic capacitor, 10 µF	Murata	GRM422Y5V106Z050AL	
C3, C7, C11, C16, C21, C26	Ceramic capacitor, 1 µF		Digi-Key 445-1411-2-ND	
C4, C8, C12, C15, C20, C25	Capacitor, 0.1 µF	Digi-Key	399-1267-2-ND	
C5, C9, C13, C14, C19, C24, C33	Ceramic capacitor, 12 pF	ATC	600S120JT	
C29, C30, C31	Ceramic capacitor, 1.8 pF	ATC	600S1R8CT	
C32	Ceramic capacitor, 1.0 pF	ATC	100B 1R0	
Q1, Q2	Transistor	Infineon Technologies	BCP56	
R1, R2	Resistor, 0 Ω	Digi-Key	603	
R3, R4	Potentiometer, 2k Ω	Digi-Key	3224W-202ETR-ND	

PTMA180402M

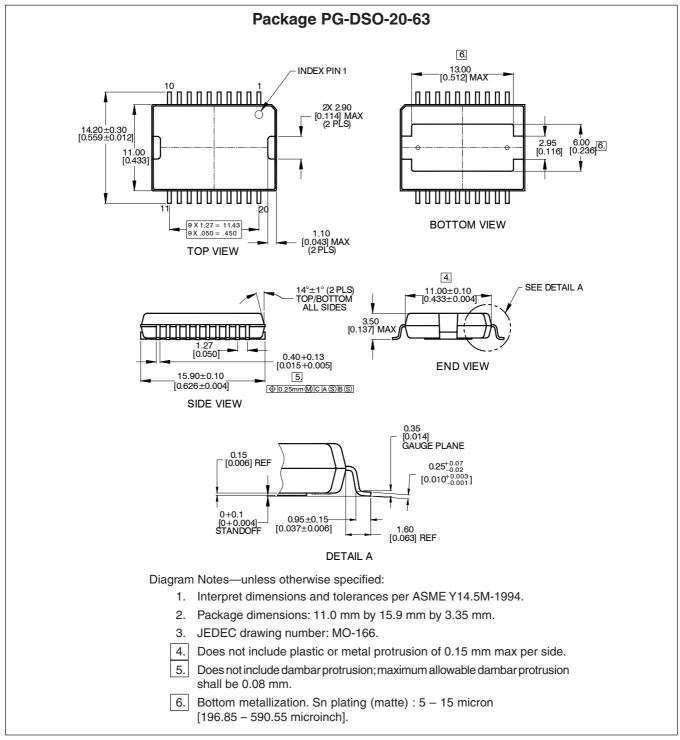


Pinout Diagram





Package Outline Specifications



Refer to Application Note "Recommendations for Printed Circuit Board Assembly of Infineon DSO and SSOP Packages" for additional information.

PTMA180402M V1

Revision His	story: 2011-08-10	Data Sheet
Previous Ve	rsion: 2011-03-17, Data Sheet	
Page	Subjects (major changes since last revision)	
1	Revisions to RF characteristics.	
2	Changes to V _{(BR)DSS} and R _{DS(on)} , DC table	
3, 11	Corrected typos.	
9	Removed voltage vs. temperature graph.	
all	Miscellaneous cosmetic adjustments.	

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highpowerRF@infineon.com

To request other information, contact us at: +1 877 465 3667 (1-877-GO-LDMOS) USA or +1 408 776 0600 International



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